74LVC244A; 74LVCH244A

Octal buffer/line driver; 3-state

Rev. 11 — 29 April 2021

Product data sheet

1. General description

The 74LVC244A; 74LVCH244A is an octal non-inverting buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs 1OE and 2OE. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state. Schmitt-trigger action at all inputs makes the circuit highly tolerant for slower input rise and fall times.

Inputs can be driven from either 3.3~V or 5.0~V devices. In 3-state operation, outputs can handle 5~V. These features allow the use of these devices as translators in a mixed 3.3~V and 5~V environment.

The 74LVCH244A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- · CMOS low-power consumption
- Direct interface with TTL levels
- Inputs accept voltages up to 5.5 V
- High-impedance when V_{CC} = 0 V
- Bus hold on all data inputs (74LVCH244A only)
- · Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

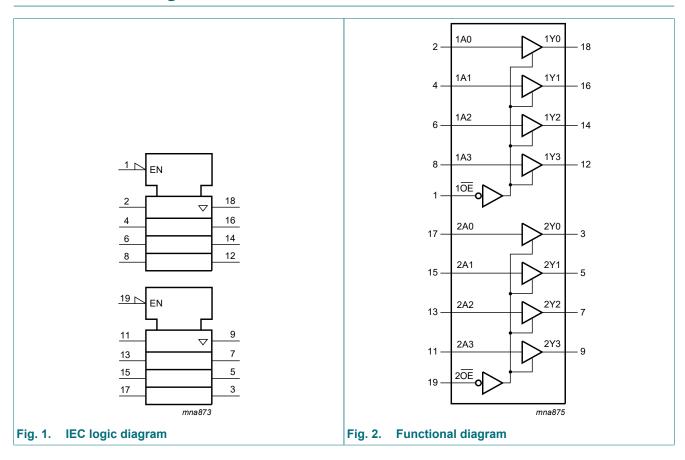


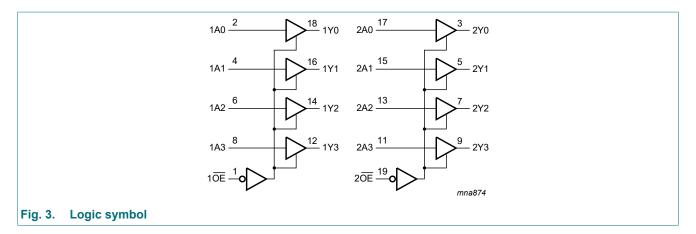
3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC244AD	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1
74LVCH244AD			body width 7.5 mm	
74LVC244ADB	-40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74LVC244APW	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1
74LVCH244APW			body width 4.4 mm	
74LVC244ABQ	-40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal	SOT764-1
74LVCH244ABQ			enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	
74LVC244ABZ	-40 °C to +125 °C	DHXQFN20	plastic, leadless dual in-line compatible thermal enhanced extreme thin quad flat package; no leads; 20 terminals; 0.4 mm pitch; body 2 mm × 3.2 mm × 0.48 mm	SOT8020-1

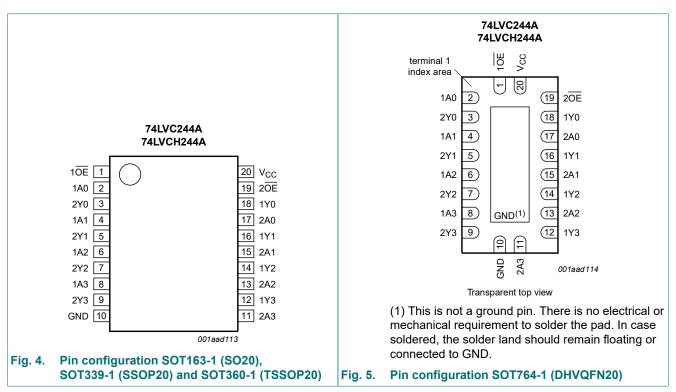
4. Functional diagram

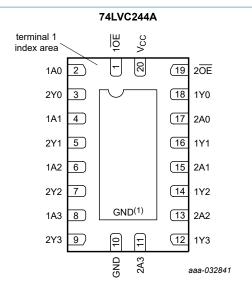




5. Pinning information

5.1. Pinning





Transparent top view

Fig. 6. Pin configuration SOT8020-1 (DHXQFN20)

5.2. Pin description

Table 2. Pin description

Pin	Description
1, 19	output enable input (active low)
2, 4, 6, 8	data input
3, 5, 7, 9	data output
10	ground (0 V)
17, 15, 13, 11	data input
18, 16, 14, 12	data output
20	supply voltage
	1, 19 2, 4, 6, 8 3, 5, 7, 9 10 17, 15, 13, 11 18, 16, 14, 12

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

	Input	Output
nŌE	nAn	nYn
L	L	L
L	Н	Н
Н	X	Z

⁽¹⁾ This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

		, ,			,,,	,
Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V		-	±50	mA
Vo	output voltage	output HIGH or LOW	[2]	-0.5	V _{CC} + 0.5	V
		output 3-state	[2]	-0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C				
		SOT163-1; SOT339-1; SOT360-1; SOT764-1	[3]	-	500	mW
		SOT8020-1		-	250	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.2 V to 2.7 V	0	-	20	ns/V
		V_{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SOT163-1 (SO20) package: P_{tot} derates linearly with 12.3 mW/K above 109 °C. For SOT339-1 (SSOP20) package: P_{tot} derates linearly with 10.0 mW/K above 100 °C. For SOT360-1 (TSSOP20) package: P_{tot} derates linearly with 10.0 mW/K above 100 °C. For SOT764-1 (DHVQFN20) package: P_{tot} derates linearly with 12.9 mW/K above 111 °C.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		-40	°C to +85	S °C	-40 °C to	+125 °C	Unit
				Min	Typ [1]	Max	Min	Max	
V _{IH}	HIGH-level input	V _{CC} = 1.2 V		1.08	-	-	1.08	-	V
	voltage	V _{CC} = 1.65 V to 1.95 V		0.65V _{CC}	-	-	0.65V _{CC}	-	V
		V _{CC} = 2.3 V to 2.7 V		1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V		2.0	-	-	2.0	-	V
V _{IL}	LOW-level input	V _{CC} = 1.2 V		-	-	0.12	-	0.12	V
	voltage	V _{CC} = 1.65 V to 1.95 V		-	-	0.35V _{CC}	-	0.35V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V		-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V		-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}							
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$		V _{CC} - 0.2	-	-	V _{CC} - 0.3	-	V
		I_{O} = -4 mA; V_{CC} = 1.65 V		1.2	-	-	1.05	-	V
		$I_O = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$		1.8	-	-	1.65	-	V
		I_{O} = -12 mA; V_{CC} = 2.7 V		2.2	-	-	2.05	-	V
		$I_O = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$		2.4	-	-	2.25	-	V
		$I_O = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$		2.2	-	-	2.0	-	V
V _{OL}	LOW-level output	$V_I = V_{IH}$ or V_{IL}							
	voltage	I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V		-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$		-	-	0.45	-	0.65	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$		-	-	0.6	-	0.8	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$		-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$		-	-	0.55	-	0.8	V
I _I	input leakage current	$V_1 = 5.5 \text{ V or GND}; V_{CC} = 3.6 \text{ V}$	[2]	-	±0.1	±5	-	±20	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_O = 5.5$ V or GND; $V_{CC} = 3.6$ V	[2]	-	±0.1	±5	-	±20	μΑ
l _{OFF}	power-off leakage current	V_{I} or $V_{O} = 5.5 \text{ V}$; $V_{CC} = 0.0 \text{ V}$		-	±0.1	±10	-	±20	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6$ V		-	0.1	10	-	40	μΑ
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 0.6 \text{ V}$; $I_O = 0 \text{ A}$; $V_{CC} = 2.7 \text{ V}$ to 3.6 V		-	5	500	-	5000	μΑ
Cı	input capacitance			-	4.0	-	-	-	pF

Symbol	Parameter	Conditions		-40	°C to +85	°C	-40 °C to	+125 °C	Unit
				Min	Typ [1]	Max	Min	Max	
I _{BHL}	bus hold LOW current	V _{CC} = 1.65 V; V _I = 0.58 V	[3] [4]	10	-	-	10	-	μΑ
		V _{CC} = 2.3 V; V _I = 0.7 V		30	-	-	25	-	μΑ
		V _{CC} = 3.0 V; V _I = 0.8 V		75	-	-	60	-	μΑ
I _{BHH}	bus hold HIGH current	V _{CC} = 1.65 V; V _I = 1.07 V	[3] [4]	-10	-	-	-10	-	μΑ
		V _{CC} = 2.3 V; V _I = 1.7 V		-30	-	-	-25	-	μΑ
		V _{CC} = 3.0 V; V _I = 2.0 V		-75	-	-	-60	-	μΑ
I _{BHLO}	bus hold LOW overdrive current	V _{CC} = 1.95 V	[3] [5]	200	-	-	200	-	μΑ
		V _{CC} = 2.7 V		300	-	-	300	-	μΑ
		V _{CC} = 3.6 V		500	-	-	500	-	μΑ
Івнно	bus hold HIGH overdrive current	V _{CC} = 1.95 V	[3] [5]	-200	-	-	-200	-	μΑ
		V _{CC} = 2.7 V		-300	-	-	-300	-	μΑ
		V _{CC} = 3.6 V		-500	-	-	-500	-	μΑ

- [1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C. [2] The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input terminal.
- Valid for data inputs of bus hold parts only (74LVCH244A). Note that control inputs do not have a bus hold circuit. [3]
- The specified sustaining current at the data input holds the input below the specified V_I level.
- The specified overdrive current at the data input forces the data input to the opposite input state.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 9.

Symbol	Parameter	Conditions	-4	0 °C to +85	°C	-40 °C to	+125 °C	Unit
			Min	Typ [1]	Max	Min	Max	
t _{pd}	propagation delay	nAn to nYn; see Fig. 7 [2]					
		V _{CC} = 1.2 V	-	17.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.5	6.4	13.7	1.5	15.8	ns
		V _{CC} = 2.3 V to 2.7 V	1.0	3.4	7.1	1.0	8.2	ns
		V _{CC} = 2.7 V	1.5	3.4	6.9	1.5	9.0	ns
		V _{CC} = 3.0 V to 3.6 V	1.5	2.9	5.9	1.5	7.5	ns
t _{en}	enable time	nOE to nYn; see Fig. 8]					
		V _{CC} = 1.2 V	-	24.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.5	7.0	17.3	1.5	20.0	ns
		V _{CC} = 2.3 V to 2.7 V	1.5	3.9	9.5	1.5	11.0	ns
		V _{CC} = 2.7 V	1.5	4.1	8.6	1.5	11.0	ns
		V _{CC} = 3.0 V to 3.6 V	1.0	3.2	7.6	1.0	9.5	ns
t _{dis}	disable time	nOE to nYn; see Fig. 8]					
		V _{CC} = 1.2 V	-	9.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	2.2	4.5	9.8	2.2	11.3	ns
		V _{CC} = 2.3 V to 2.7 V	0.5	3.6	5.5	0.5	6.4	ns
		V _{CC} = 2.7 V	1.5	3.3	6.8	1.5	8.5	ns
		V _{CC} = 3.0 V to 3.6 V	1.5	3.1	5.8	1.5	7.5	ns
t _{sk(o)}	output skew time	[3] -	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per input; $V_I = GND$ to V_{CC} [4]					
	capacitance	V _{CC} = 1.65 V to 1.95 V	-	6.4	-	-	-	pF
		V _{CC} = 2.3 V to 2.7 V	-	9.6	-	-	-	pF
		V _{CC} = 3.0 V to 3.6 V	-	12.5	-	-	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

 t_{en} is the same as t_{PZL} and $t_{\text{PZH}}.$

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

 C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

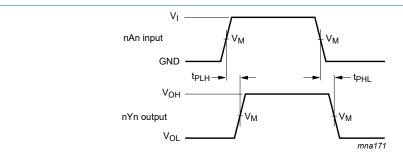
V_{CC} = supply voltage in Volts

N = number of inputs switching $\Sigma(C_L \times V_{CC}^{\ 2} \times f_o) = \text{sum of the outputs}.$

t_{pd} is the same as t_{PLH} and t_{PHL}.

Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

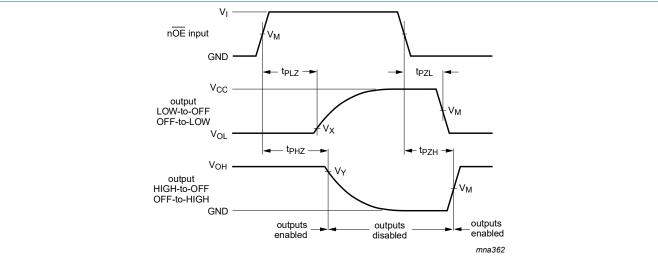
10.1. Waveforms and test circuit



Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 7. The input (nAn) to output (nYn) propagation delays



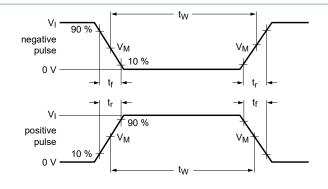
Measurement points are given in Table 8.

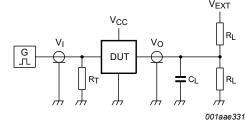
Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 8. 3-state enable and disable times

Table 8. Measurement points

Supply voltage	Input		Output						
V _{CC}	VI	V _M	V _M	V _X	V _Y				
1.2 V	V _{CC}	0.5 × V _{CC}	0.5 × V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V				
1.65 V to 1.95 V	V _{CC}	0.5 × V _{CC}	0.5 × V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V				
2.3 V to 2.7 V	V _{CC}	0.5 × V _{CC}	0.5 × V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V				
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V				
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V				





Test data is given in Table 9.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig. 9. Test circuit for measuring switching times

Table 9. Test data

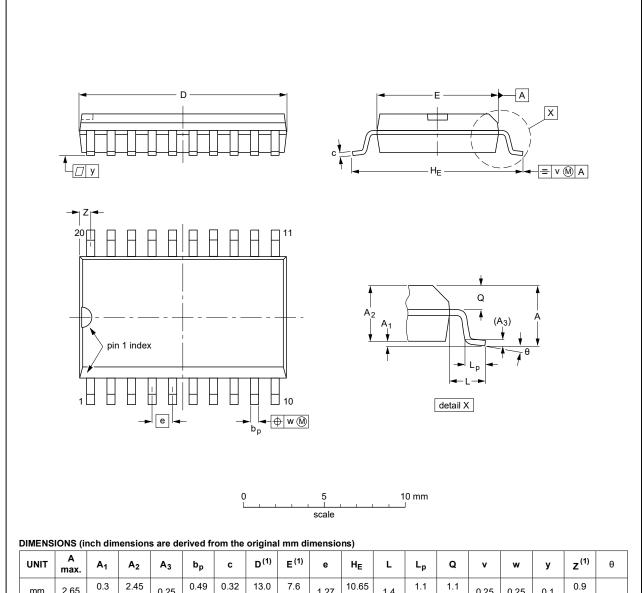
Supply voltage	Input		Load		V _{EXT}			
	V _I	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	open	2 × V _{CC}	GND	
1.65 V to 1.95 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	open	2 × V _{CC}	GND	
2.3 V to 2.7 V	V _{CC}	≤ 2 ns	30 pF	500 Ω	open	2 × V _{CC}	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 × V _{CC}	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 × V _{CC}	GND	

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11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.3 0.1	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013				99-12-27 03-02-19

Fig. 10. Package outline SOT163-1 (SO20)

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1

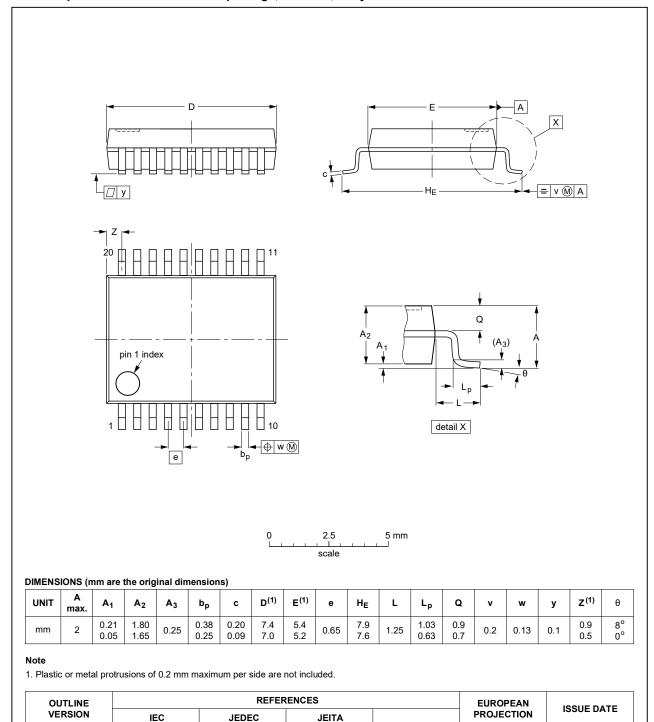


Fig. 11. Package outline SOT339-1 (SSOP20)

SOT339-1

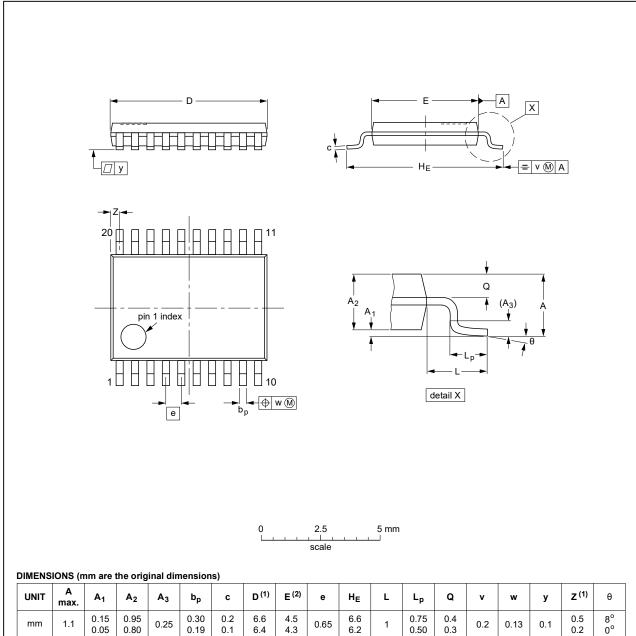
99-12-27

03-02-19

MO-150

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT360-1		MO-153				99-12-27 03-02-19

Fig. 12. Package outline SOT360-1 (TSSOP20)

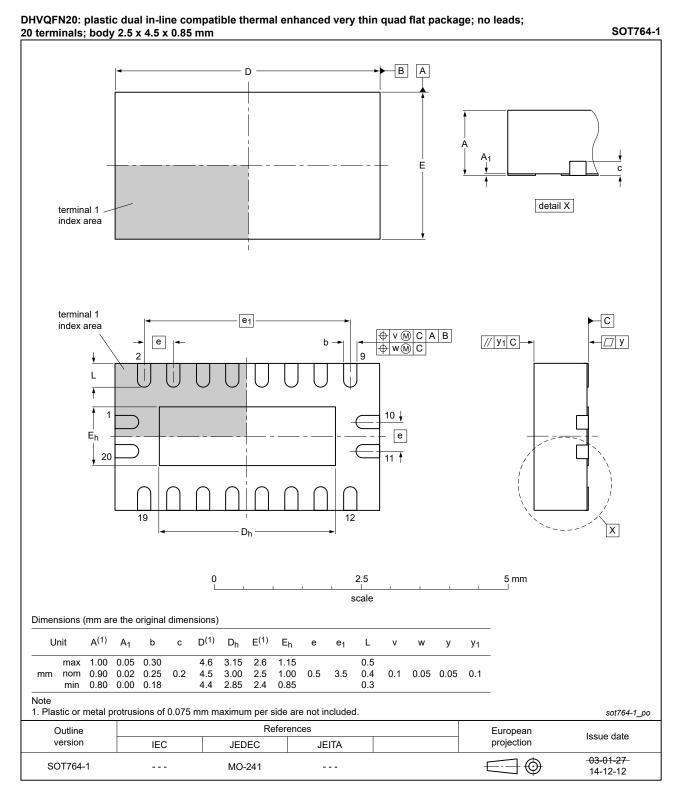


Fig. 13. Package outline SOT764-1 (DHVQFN20)

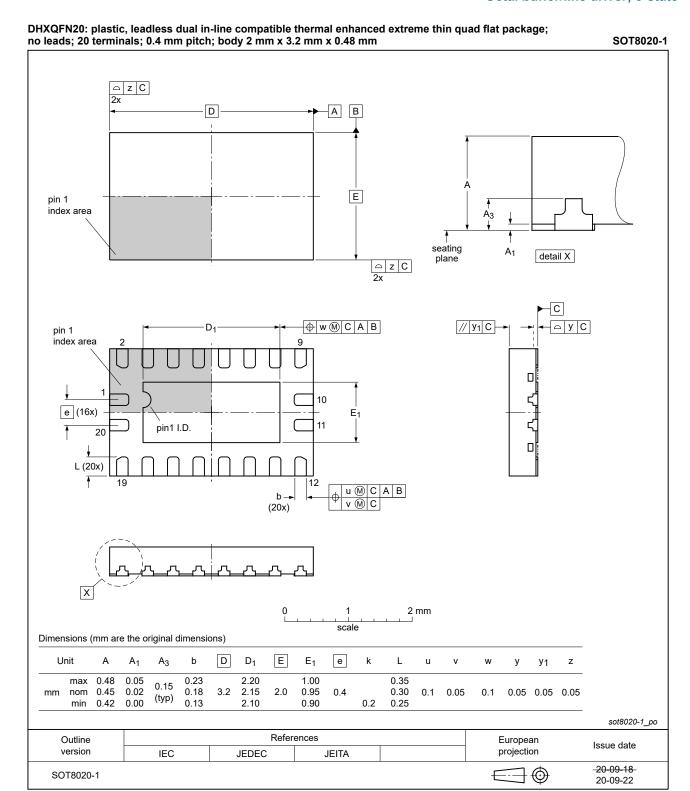


Fig. 14. Package outline SOT8020-1 (DHXQFN20)

12. Abbreviations

Table 10. Abbreviations

14010 1017 10010 114410110				
Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC_LVCH244A v.11	20210429	Product data sheet	-	74LVC_LVCH244A v.10	
Modifications:		er 74LVC244ABZ (SOT er 74LVCH244ADB (SO		•	
74LVC_LVCH244A v.10	20200408	Product data sheet	-	74LVC_LVCH244A v.9	
Modifications:	• Table 4: De	rating values for P _{tot} to	tal power dissipat	ion updated.	
74LVC_LVCH244A v.9	20180813	Product data sheet	-	74LVC_LVCH244A v.8	
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type numbers 74LVC244ABX and 74LVCH244ABX (SOT1045-2) removed. 				
74LVC_LVCH244A v.8	20130626	Product data sheet	-	74LVC_LVCH244A v.7	
Modifications:	7.	mbers 74LVC244ABX and to DHXQFN20 (SOT		ABX DHXQFN20U (SOT1045-1)	
74LVC_LVCH244A v.7	20111122	Product data sheet	-	74LVC_LVCH244A v.6	
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Table 4, Table 5, Table 6, Table 7, Table 8 and Table 9: values added for lower voltage ranges. 				
74LVC_LVCH244A v.6	20090813	Product data sheet	-	74LVC_LVCH244A v.5	
74LVC_LVCH244A v.5	20090709	Product data sheet	-	74LVC_LVCH244A v.4	
74LVC_LVCH244A v.4	20031030	Product specification	-	74LVC_LVCH244A v.3	
74LVC_LVCH244A v.3	20030520	Product specification	-	74LVC_H244A v.2	
74LVC_H244A v.2	19980520	Product specification	-	74LVC244A_74LVCH244A v.1	
74LVC244A_74LVCH244A v.1	19960906	Product specification	-	-	

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14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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